

2027 2nd International Conference on Electromagnetic Engineering & Microwave Systems

June 11-13, 2027 Hangzhou, China

EEMS 2027

www.iceems.org

Taking place from June 11 to 13, 2027 2nd International Conference on Electromagnetic Engineering & Microwave Systems (EEMS 2027) will be held in Hangzhou, China. Co-sponsored by Yangtze Delta Region Academy of Beijing Institute of Technology (Jiaxing), Zhejiang University, Hangzhou Dianzi University, and Ningbo University, the conference aims to fully leverage Hangzhou's unique strengths in fostering innovation, creating a world-class international exchange platform that brings together global academics, industry leaders, and technology innovators. It will serve as a dynamic venue for sharing cutting-edge insights, building cross-border collaboration networks, and driving technological advancements in the fields of electromagnetic engineering and microwave systems.

CALL FOR PAPERS:

Track 6: Electromagnetic Compatibility and Safety

Track Chair:



Prof. Changzhou Hua
Ningbo University, China

System-Level EMC Design and Layout

Electromagnetic Interference (EMI) Suppression Technologies

Signal Integrity (SI) for High-Speed Digital Links

Power Integrity (PI) Analysis and Design

Shielding and Grounding Technologies

EMC Design for 5G/6G Systems

EMC Testing and Certification for Automotive Electronics

PCB-Level EMC Simulation and Optimization

Multiphysics Compatibility Design and Management

More information about topics, please visit: *https://www.iceems.org/cfp.html*

SUBMISSION

The manuscript in double-column format should have at least 4 full pages and up to 10 pages. If it exceeds 5 pages, the extra page(s) will be charged. Manuscripts must be written in English and follow the instructions at Manuscript Formatting and Templates.
Submission system: *https://www.zmeeting.org/submission/eems2027*

PUBLICATION

All submissions will be sent for double-blind review. Accepted papers with registration and presentation will be published in Conference Proceedings, and submitted for index by Ei Compendex and Scopus.

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